

P-Channel PowerTrench[®] MOSFET -30 V, -18 A, 20 m Ω

Features

- Max $r_{DS(on)}$ = 20 m Ω at V_{GS} = -10 V, I_D = -9.0 A
- Max $r_{DS(on)}$ = 37 mΩ at V_{GS} = -4.5 V, I_D = -6.5 A
- \blacksquare Extended V_{GSS} range (-25 V) for battery applications
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability
- HBM ESD protection level >7 kV typical (Note 4)
- 100% UIL tested
- Termination is Lead-free and RoHS Compliant

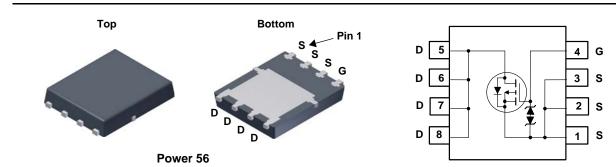


General Description

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Applications

- High side in DC-DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			-30	V
V _{GS}	Gate to Source Voltage			±25	V
I _D	Drain Current -Continuous (Package limited)	T _C = 25 °C		-18	
	-Continuous (Silicon limited)	T _C = 25 °C		-35	^
	-Continuous	T _A = 25 °C	(Note 1a)	-9.0	Α
	-Pulsed			-50	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	18	mJ
D	Power Dissipation	T _C = 25 °C		39	W
P _D	Power Dissipation $T_A = 25 \text{ °C}$ (Note 1a)		(Note 1a)	2.5	vv
T _J , T _{STG}	Operating and Storage Junction Temperature R	ange		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS4435BZ	FDMS4435BZ	Power 56	13 "	12 mm	3000 units

October 2014

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, referenced to 25 °C		-23		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$	-1.0	-1.9	-3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250 µA, referenced to 25 °C		6		mV/°C
		V _{GS} = -10 V, I _D = -9.0 A		15	20	
r	Static Drain to Source On Resistance	V_{GS} = -4.5 V, I _D = -6.5 A		22	37	mΩ
r _{DS(on)}		V _{GS} = -10 V, I _D = -9.0 A T _J = 125 °C		21	28	- 11122
9 _{FS}	Forward Transconductance	V _{DS} = -5 V, I _D = -9.0 A		25		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	N/ 45.1/. 2.1/		1540	2050	pF
C _{oss}	Output Capacitance	── V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz		290	390	pF
C _{rss}	Reverse Transfer Capacitance			260	385	pF
R _g	Gate Resistance			5		Ω

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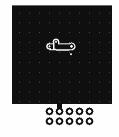
Switching Characteristics

t _{d(on)}	Turn-On Delay Time		9	17	ns
t _r	Rise Time	V _{DD} = -15 V, I _D = -9.0 A,	10	18	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	35	56	ns
t _f	Fall Time		19	33	ns
Qg	Total Gate Charge	$V_{GS} = 0 V$ to -10 V	34	47	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } -4.5 V V_{DD} = -15 V,$	18	25	nC
Q _{gs}	Gate to Source Charge	I _D = -9.0 A	5		nC
Q _{gd}	Gate to Drain "Miller" Charge		9		nC

Drain-Source Diode Characteristics

V Source to Dra	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -1.9 A$ (Note 2)	0.75	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -9.0 A$ (Note 2)	0.86	1.5	v
t _{rr}	Reverse Recovery Time	L = 0.0.4 di/dt = 100.4/vp	25	39	ns
Q _{rr}	Reverse Recovery Charge	I _F = -9.0 A, di/dt = 100 A/μs		21	nC
Notes:					

1. R_{0,J} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper

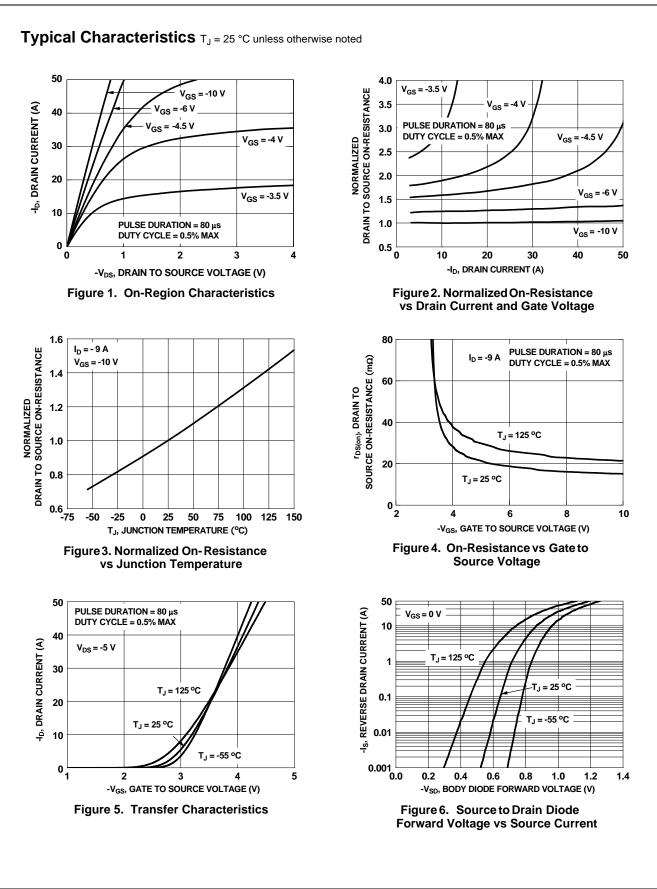
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.



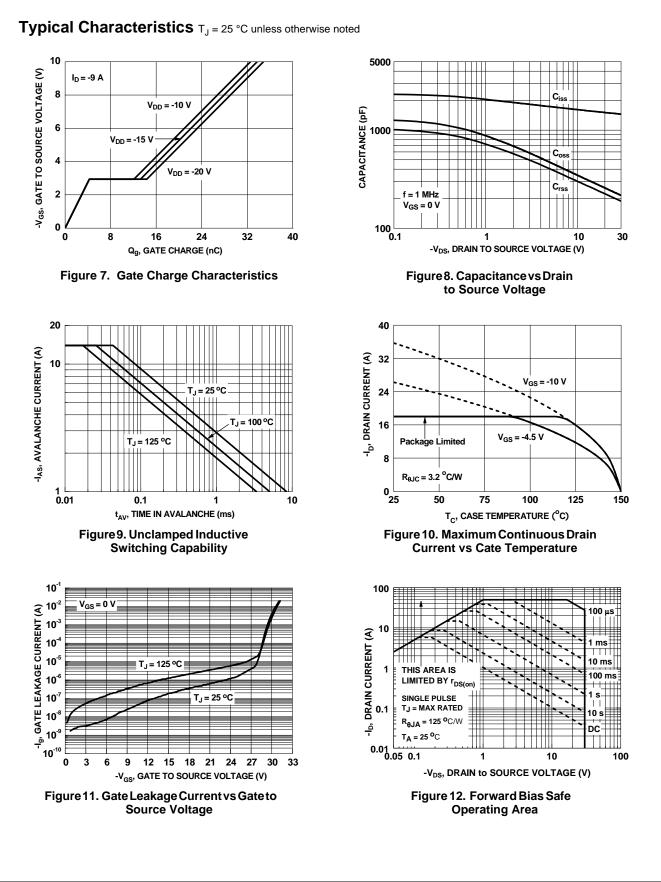
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%. 3. E_{AS} of 18 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = -6 A, V_{DD} = -27 V, V_{GS} = -10 V. 100% tested at L = 0.3 mH, I_{AS} = -8 A.

4. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

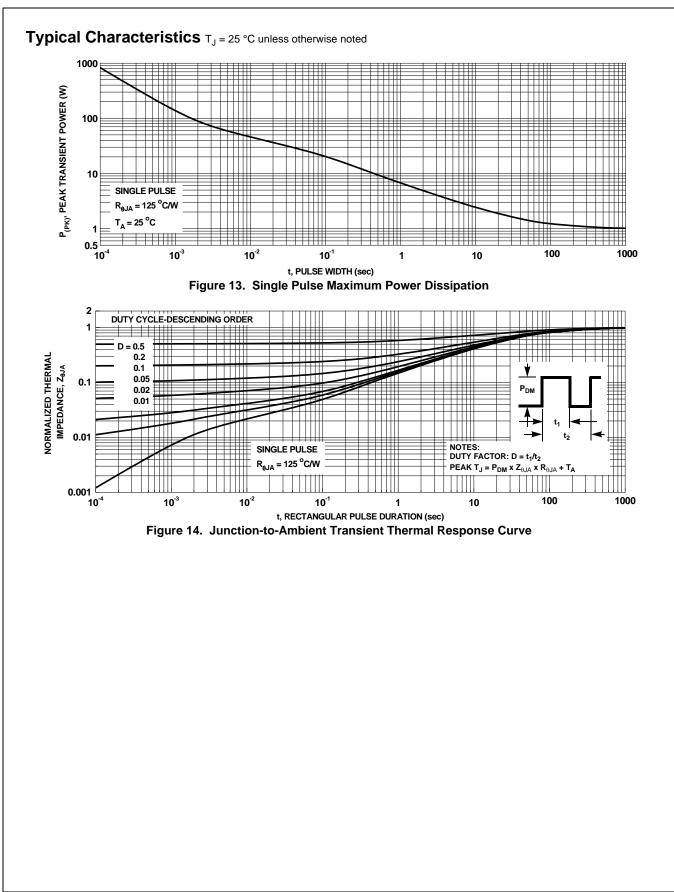
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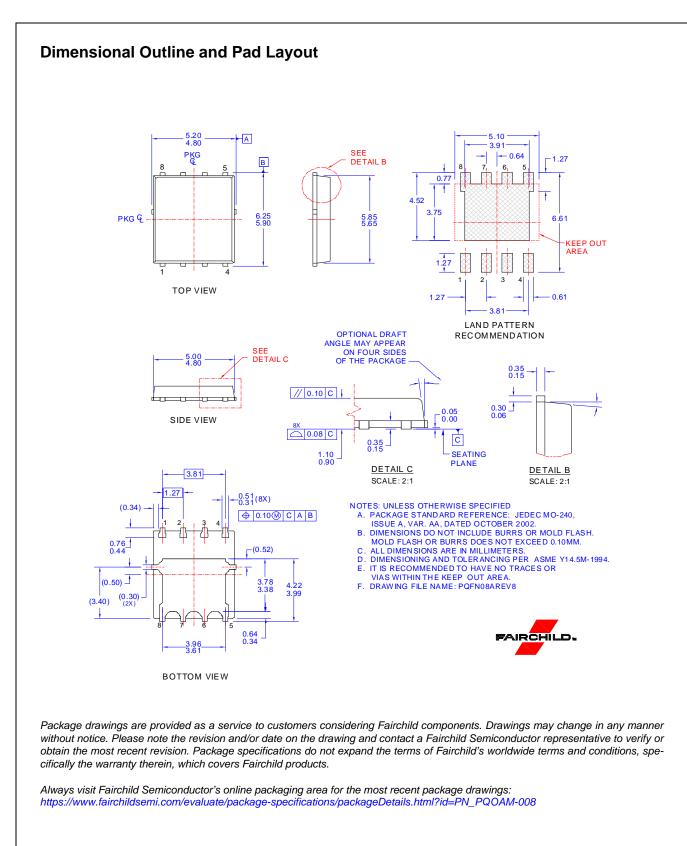


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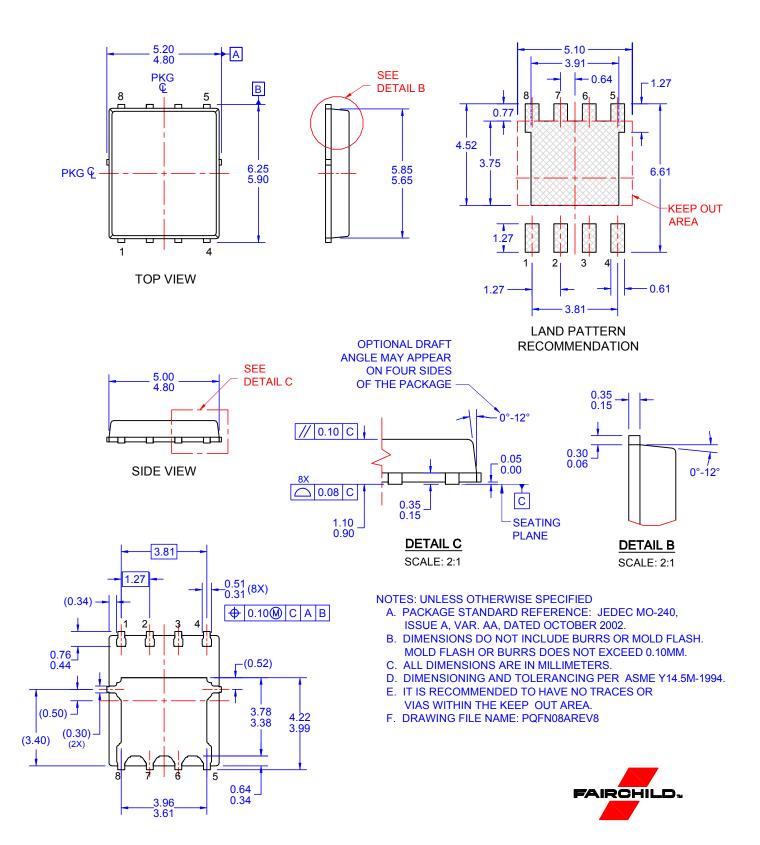
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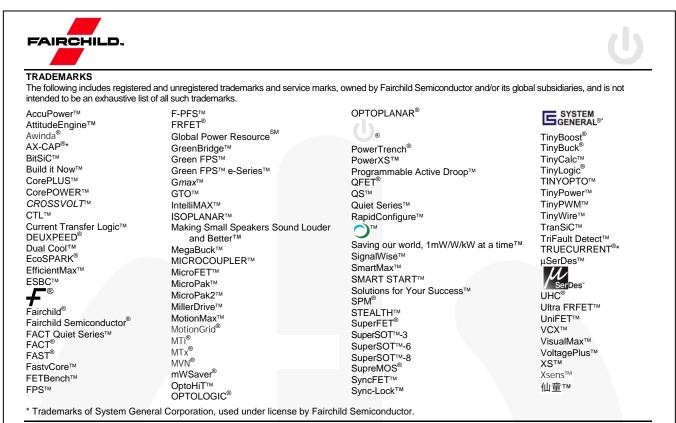
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